

## EMIF02-SPK01C2

### 2 line EMI filter and ESD protection

### Main product characteristics

Where EMI filtering in ESD sensitive equipment is required:

- Mobile phones and communication systems
- Computers and printers and MCU Boards

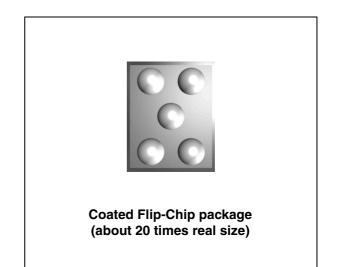
### Description

The EMIF02-SPK01C2 is a highly integrated device designed to suppress EMI/RFI noise in all systems subjected to electromagnetic interference. The Flip-Chip packaging means the package size is equal to the die size.

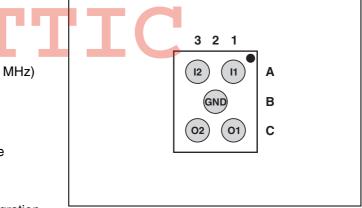
This filter includes ESD protection circuitry, which prevents damage to the application when it is subjected to ESD surges up to 15 kV.

### Benefits

- EMI symmetrical (I/O) low-pass filter
- High efficiency EMI filter (-33 dB @ 900 MHz)
- Very low PCB space consumption: 1.07 mm x 1.47 mm
- Very thin package: 0.695 mm
- Coating resin on back side and lead free package
- High efficiency in ESD suppression
- High reliability offered by monolithic integration
- High reduction of parasitic elements through integration and wafer level packaging.



### Pin configuration (Bump side)



### Complies with following standards:

#### IEC 61000-4-2

level 4 input pins	15 kV	(air discharge)
	8 kV	(contact discharge
level 1 output pins	2 kV	(air discharge)
	2 kV	(contact discharge

### MIL STD 883G - Method 3015-7 Class 3

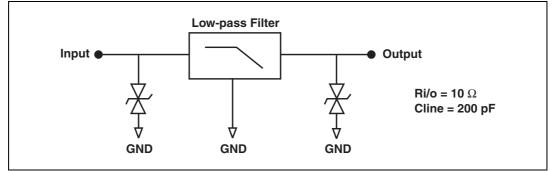
Rev 1

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Characteristics

### 1 Characteristics

### Figure 1. Basic cell configuration



#### Table 1. Absolute ratings (limiting values)

Symbol	Parameter	Value	Unit
Тj	Maximum junction temperature	125	°C
T <sub>op</sub>	Operating temperature range	-40 to +85	°C
T <sub>stg</sub>	Storage temperature range	-55 to +150	°C

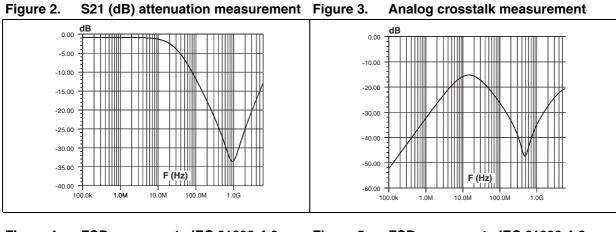
### Table 2. Electrical characteristics ( $T_{amb} = 25^{\circ} C$ )

Symbol	Parameters	
V <sub>BR</sub>	Breakdown voltage	
I <sub>RM</sub>	Leakage <mark>curre</mark> nt @ V <sub>RM</sub>	
V <sub>RM</sub>	Stand-off voltage	
V <sub>CL</sub>	Clamping voltage	
R <sub>d</sub>	Dynamic impedance	IR IR
I <sub>PP</sub>	Peak pulse current	
R <sub>I/O</sub>	Series resistance between input and output	Ірр
C <sub>line</sub>	Input capacitance per line	1

Symbol	Test conditions	Min	Тур	Max	Unit
V <sub>BR</sub>	/ <sub>BR</sub> I <sub>R</sub> = 1 mA		8		V
I <sub>RM</sub>	V <sub>RM</sub> = 3 V per line			500	nA
R <sub>I/O</sub> Tolerance ±20%			10		Ω
C <sub>line</sub> V <sub>R</sub> = 0 V			200		pF

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#### EMIF02-SPK01C2



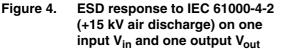


Figure 5. ESD response to IEC 61000-4-2 (- 15 kV air discharge) on one input V<sub>in</sub> and one output V<sub>out</sub>

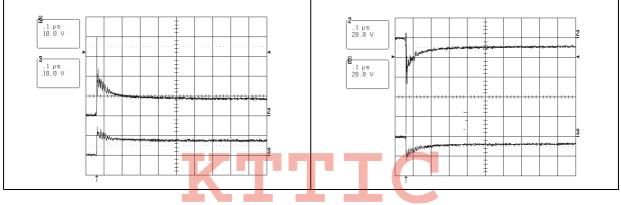
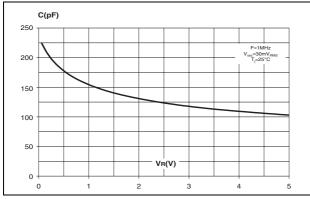


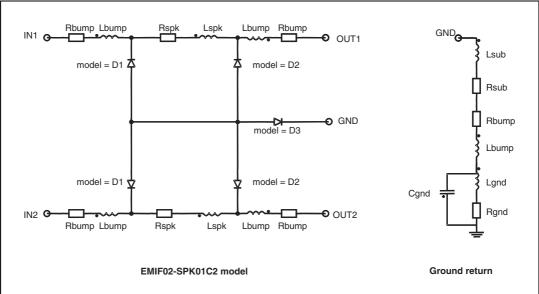
Figure 6. Line capacitance versus applied voltage



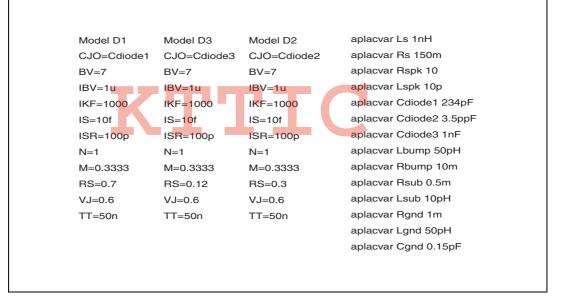
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### Characteristics





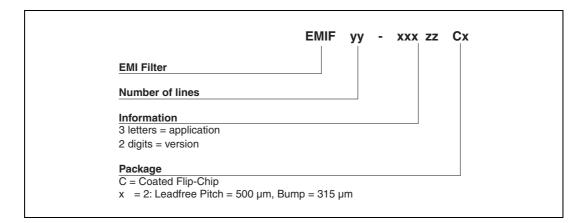




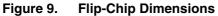


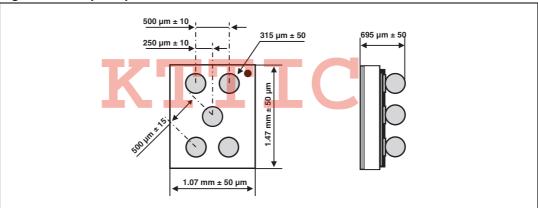
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### 2 Ordering information scheme



### 3 Package information

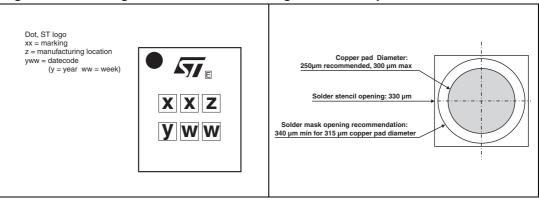




### Figure 10. Marking

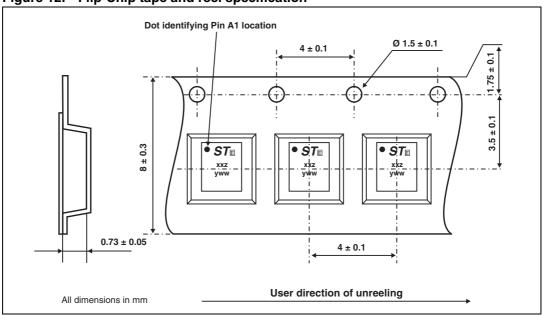
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#### **Ordering information**



#### Figure 12. Flip-Chip tape and reel specification

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

# 4 Ordering information

Ordering code	Marking	Package	Weight	Base qty	Delivery mode
EMIF02-SPK01C2	FX	Flip-Chip	2.3 mg	5000	7" Tape and reel

### 5 Revision history

Date	Revision	Changes
26-Jan-2006	1	Initial release.



#### EMIF02-SPK01C2

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